



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
 Address: COMMISSIONER FOR PATENTS  
 P.O. Box 1450  
 Alexandria, Virginia 22313-1450  
 www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 4873

<b>SERIAL NUMBER</b> 10/690,084	<b>FILING OR 371(c) DATE</b> 10/20/2003 <b>RULE</b>	<b>CLASS</b> 438	<b>GROUP ART UNIT</b> 1765	<b>ATTORNEY DOCKET NO.</b> NOVLP068/NVLS-000818
------------------------------------	---	---------------------	-------------------------------	--

## APPLICANTS

Daniel A. Koos, Chandler, AZ;  
 Steven T. Mayer, Lake Oswego, OR;  
 Heung L. Park, Wilsonville, OR;  
 Timothy Patrick Cleary, Portland, OR;  
 Thomas Mountsier, San Jose, CA;

\*\* CONTINUING DATA \*\*\*\*\* *NONE LV*\*\* FOREIGN APPLICATIONS \*\*\*\*\* *NONE LV*

IF REQUIRED, FOREIGN FILING LICENSE GRANTED \*\*  
 03/12/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY AZ	SHEETS DRAWING 3	TOTAL CLAIMS 47	INDEPENDENT CLAIMS 3
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged Examiner's Signature <i>[Signature]</i> Initials <i>LV</i>				

## ADDRESS

022434

## TITLE

Method for fabrication of semiconductor interconnect structure with reduced capacitance, leakage current, and improved breakdown voltage

<b>FILING FEE RECEIVED</b> 2670	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue ) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit
------------------------------------	---	---